

IPD75N04S406ATMA1 Datasheet



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DiGi Electronics Part Number	IPD75N04S406ATMA1-DG
Manufacturer	Infineon Technologies
Manufacturer Product Number	IPD75N04S406ATMA1
Description	MOSFET N-CH 40V 75A TO252-3
Detailed Description	N-Channel 40 V 75A (Tc) 58W (Tc) Surface Mount PG -TO252-3-313



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:

IPD75N04S406ATMA1

Series:

OptiMOS™

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

40 V

Drive Voltage (Max Rds On, Min Rds On):

10V

Vgs(th) (Max) @ Id:

4V @ 26µA

Vgs (Max):

±20V

FET Feature:

-

Operating Temperature:

-55°C ~ 175°C (Tj)

Qualification:

AEC-Q101

Supplier Device Package:

PG-TO252-3-313

Base Product Number:

IPD75N04

Manufacturer:

Infineon Technologies

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

75A (Tc)

Rds On (Max) @ Id, Vgs:

5.9mOhm @ 75A, 10V

Gate Charge (Qg) (Max) @ Vgs:

32 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

2550 pF @ 25 V

Power Dissipation (Max):

58W (Tc)

Grade:

Automotive

Mounting Type:

Surface Mount

Package / Case:

TO-252-3, DPAK (2 Leads + Tab), SC-63

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



OptiMOS[®]-T2 Power-Transistor



Features

- N-channel - Enhancement mode
- AEC qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green Product (RoHS compliant)
- 100% Avalanche tested

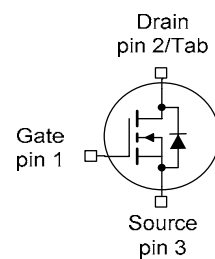
Product Summary

V_{DS}	40	V
$R_{DS(on),max}$	5.9	m Ω
I_D	75	A

PG-TO252-3-313



Type	Package	Marking
IPD75N04S4-06	PG-TO252-3-313	4N0406



Maximum ratings, at $T_j=25\text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	$T_C=25^\circ\text{C}$, $V_{GS}=10\text{V}$	75	A
		$T_C=100^\circ\text{C}$, $V_{GS}=10\text{V}^{2)}$	53	
Pulsed drain current ¹⁾	$I_{D,pulse}$	$T_C=25^\circ\text{C}$	300	
Avalanche energy, single pulse ¹⁾	E_{AS}	$I_D=35\text{A}$	72	mJ
Avalanche current, single pulse	I_{AS}	-	75	A
Gate source voltage	V_{GS}	-	± 20	V
Power dissipation	P_{tot}	$T_C=25^\circ\text{C}$	58	W
Operating and storage temperature	T_j , T_{stg}	-	-55 ... +175	$^\circ\text{C}$
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	



Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics¹⁾						
Thermal resistance, junction - case	R_{thJC}	-	-	-	2.6	K/W
Thermal resistance, junction - ambient, leaded	R_{thJA}	-	-	-	62	
SMD version, device on PCB	R_{thJA}	minimal footprint	-	-	62	
		6 cm ² cooling area ²⁾	-	-	40	

Electrical characteristics, at $T_j=25^\circ\text{C}$, unless otherwise specified

Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=1\text{mA}$	40	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=26\mu\text{A}$	2.0	3.0	4.0	
Zero gate voltage drain current	I_{DSS}	$V_{DS}=40V, V_{GS}=0V, T_j=25^\circ\text{C}$	-	0.015	1	μA
		$V_{DS}=18V, V_{GS}=0V, T_j=85^\circ\text{C}^{2)}$	-	1	20	
Gate-source leakage current	I_{GSS}	$V_{GS}=20V, V_{DS}=0V$	-	-	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=75A$	-	5.0	5.9	m Ω



Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Dynamic characteristics¹⁾

Input capacitance	C_{iss}	$V_{GS}=0\text{ V}, V_{DS}=25\text{ V},$ $f=1\text{ MHz}$	-	1960	2550	pF
Output capacitance	C_{oss}		-	490	640	
Reverse transfer capacitance	C_{rss}		-	15	35	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=20\text{V}, V_{GS}=10\text{V},$ $I_D=75\text{A}, R_G=3.5\Omega$	-	7	-	ns
Rise time	t_r		-	9	-	
Turn-off delay time	$t_{d(off)}$		-	6	-	
Fall time	t_f		-	8	-	

Gate Charge Characteristics¹⁾

Gate to source charge	Q_{gs}	$V_{DD}=32\text{V}, I_D=75\text{A},$ $V_{GS}=0\text{ to }10\text{V}$	-	11.7	15.2	nC
Gate to drain charge	Q_{gd}		-	3.5	8.1	
Gate charge total	Q_g		-	24.5	32	
Gate plateau voltage	$V_{plateau}$		-	5.9	-	V

Reverse Diode

Diode continuous forward current ¹⁾	I_S	$T_C=25^\circ\text{C}$	-	-	75	A
Diode pulse current ¹⁾	$I_{S,pulse}$		-	-	300	
Diode forward voltage	V_{SD}	$V_{GS}=0\text{V}, I_F=75\text{A},$ $T_J=25^\circ\text{C}$	-	0.9	1.3	V
Reverse recovery time ¹⁾	t_{rr}	$V_R=20\text{V}, I_F=50\text{A},$ $di_F/dt=100\text{A}/\mu\text{s}$	-	36	-	ns
Reverse recovery charge ¹⁾	Q_{rr}		-	31	-	nC

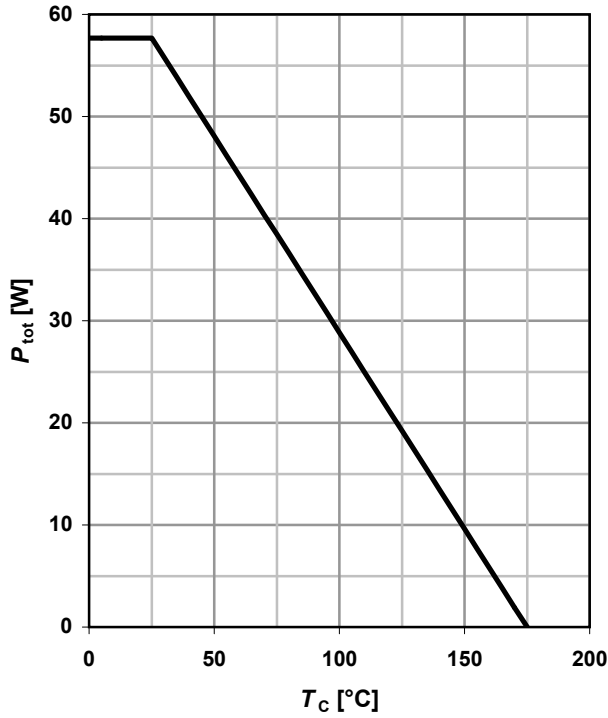
¹⁾ Defined by design. Not subject to production test.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.



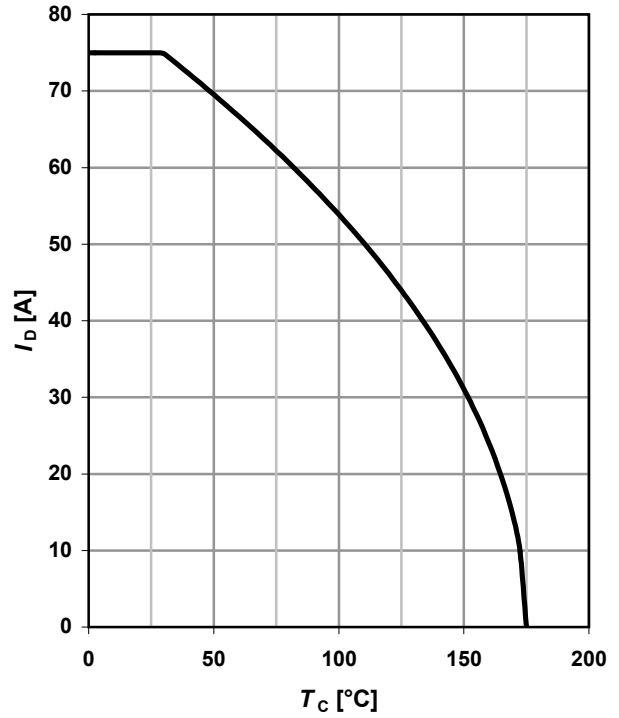
1 Power dissipation

$P_{tot} = f(T_C); V_{GS} \geq 6 V$



2 Drain current

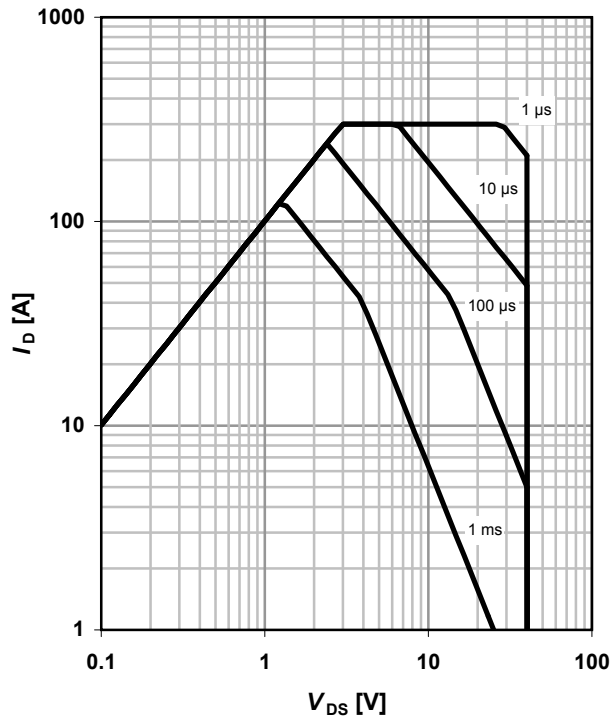
$I_D = f(T_C); V_{GS} \geq 6 V$



3 Safe operating area

$I_D = f(V_{DS}); T_C = 25^\circ C; D = 0$

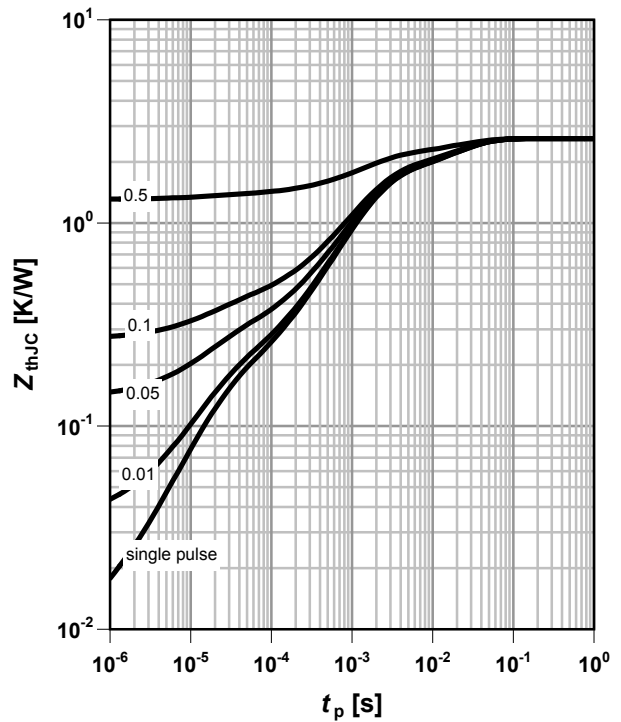
parameter: t_p



4 Max. transient thermal impedance

$Z_{thJC} = f(t_p)$

parameter: $D = t_p/T$

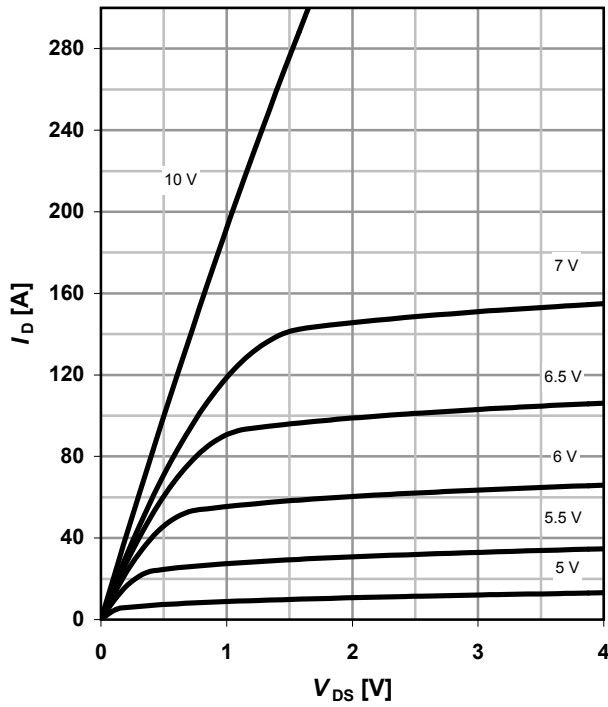




5 Typ. output characteristics

$I_D = f(V_{DS}); T_j = 25\text{ }^\circ\text{C}$

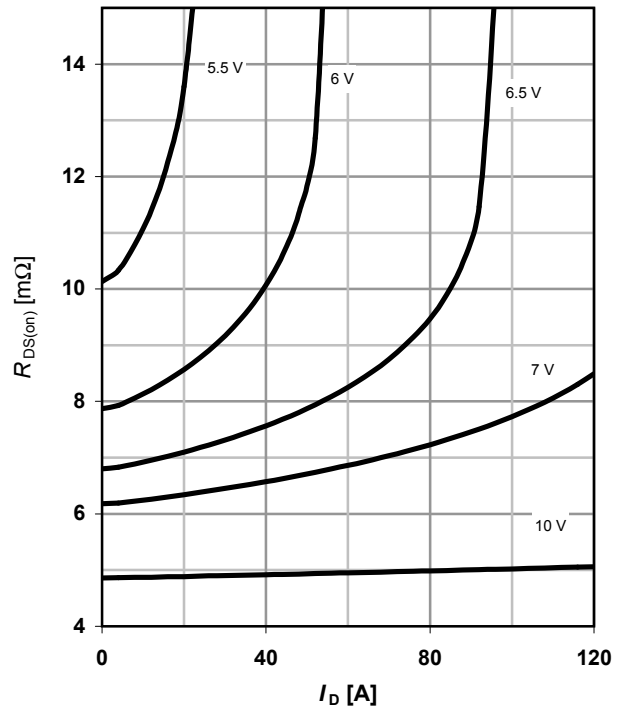
parameter: V_{GS}



6 Typ. drain-source on-state resistance

$R_{DS(on)} = f(I_D); T_j = 25\text{ }^\circ\text{C}$

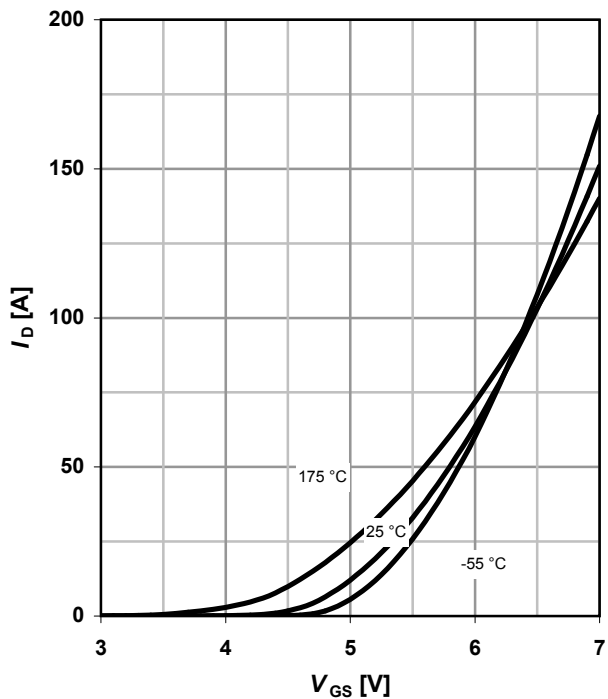
parameter: V_{GS}



7 Typ. transfer characteristics

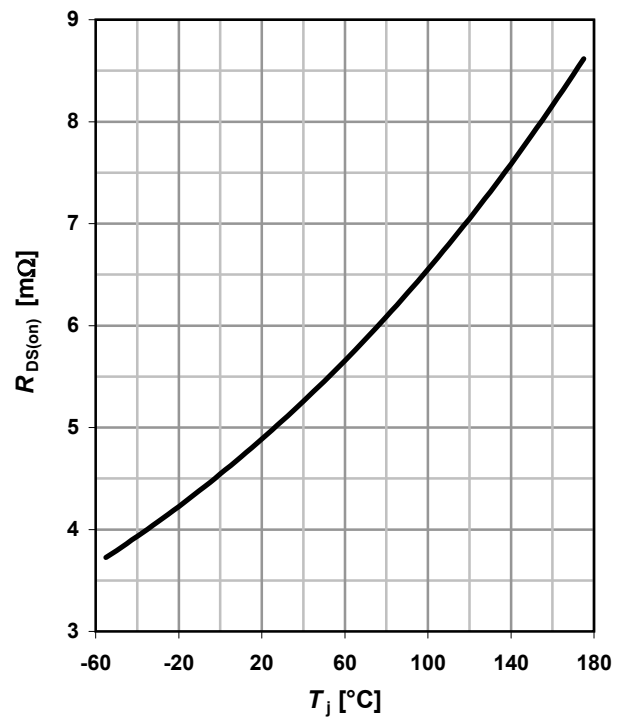
$I_D = f(V_{GS}); V_{DS} = 6\text{ V}$

parameter: T_j



8 Typ. drain-source on-state resistance

$R_{DS(on)} = f(T_j); I_D = 75\text{ A}; V_{GS} = 10\text{ V}$

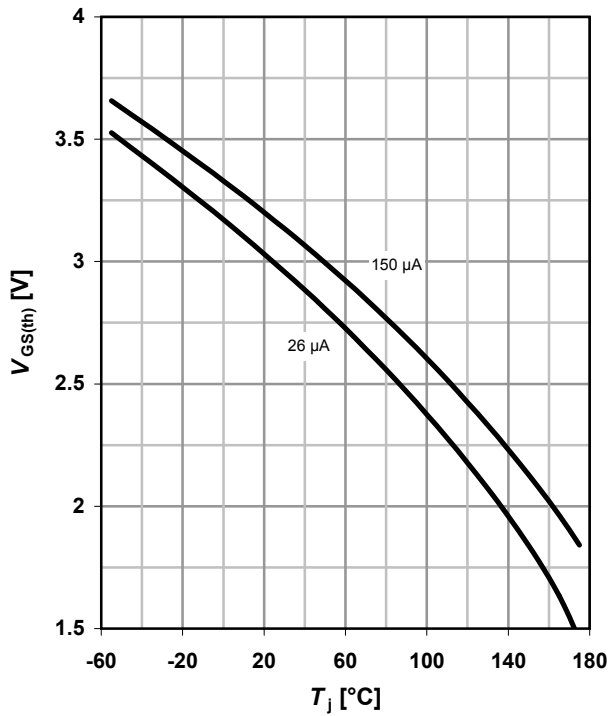




9 Typ. gate threshold voltage

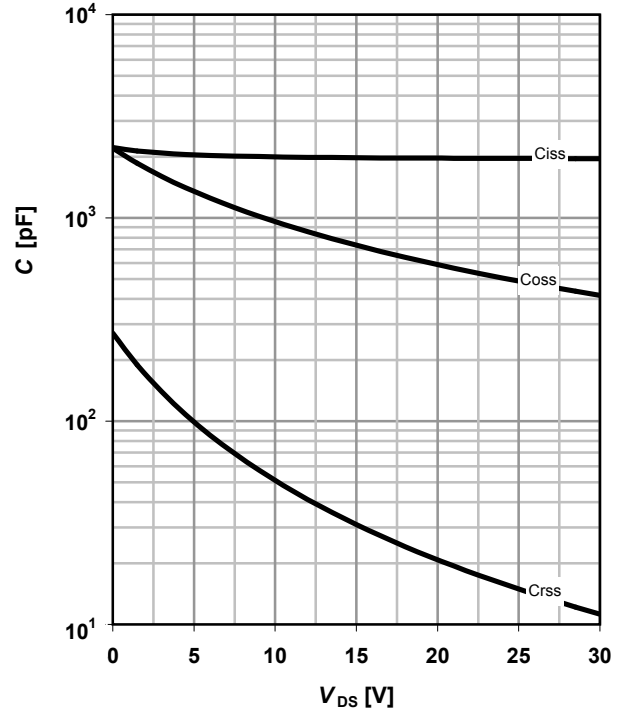
$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$

parameter: I_D



10 Typ. capacitances

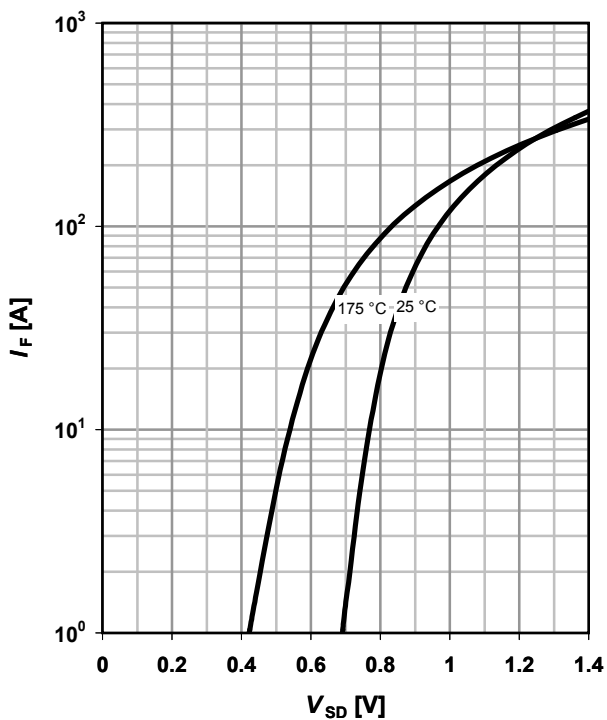
$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$



11 Typical forward diode characteristics

$I_F = f(V_{SD})$

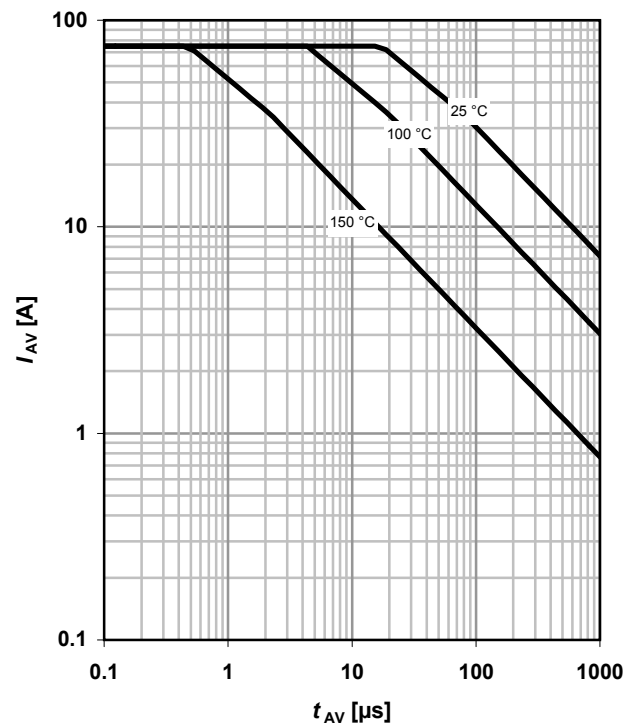
parameter: T_j



12 Avalanche characteristics

$I_{AS} = f(t_{AV})$

parameter: $T_{j(start)}$

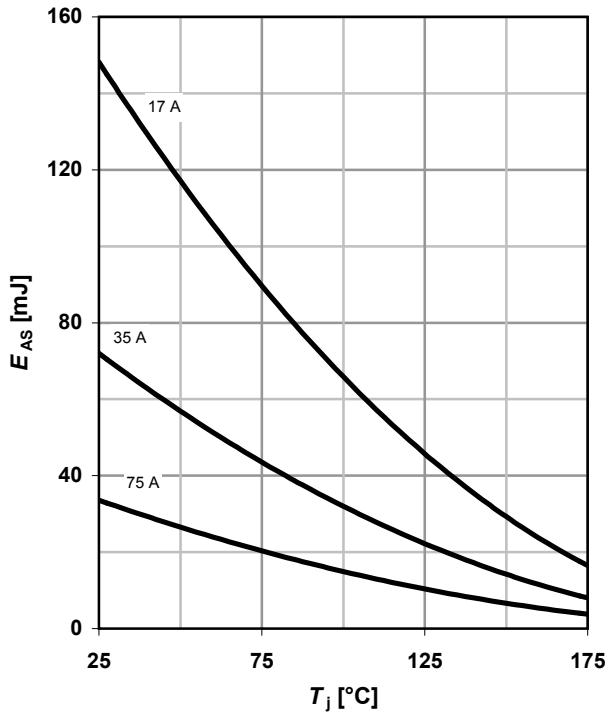




13 Avalanche energy

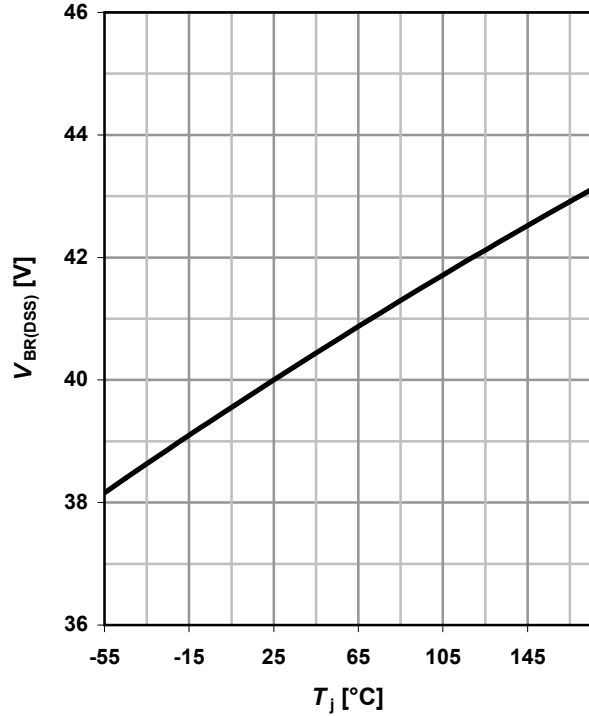
$E_{AS} = f(T_j)$

parameter: I_D



14 Drain-source breakdown voltage

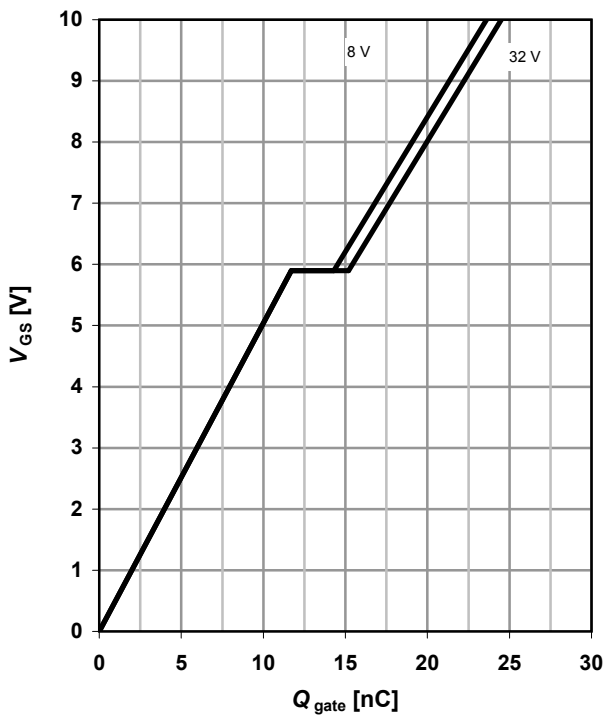
$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$



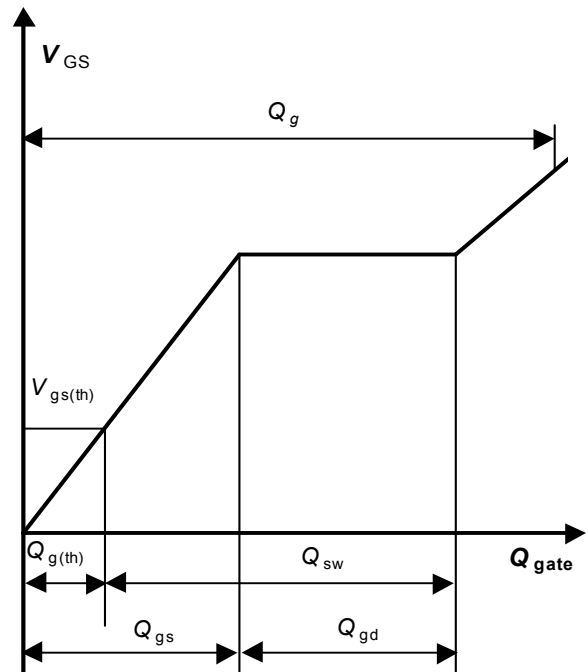
15 Typ. gate charge

$V_{GS} = f(Q_{gate}); I_D = 75 \text{ A pulsed}$

parameter: V_{DD}



16 Gate charge waveforms





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Revision History

Version	Date	Changes
Revision 1.0	06.04.2010	Final Data Sheet
Revision 1.1	15.07.2010	Update of Gate Charge diagram

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